Influence of Grain Arrangement and Crack Propagation Path on Crack Propagation Rate in Fatigue of Directionally Solidified Superalloy

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ABSTRACT. The fluctuation of J-integral, J, during high temperature fatigue crack propagation, due to the microscopic inclination of crack shape and elastic anisotropy of each grain, is investigated by means of a series of finite-element-analyses on a cracked body. The simulated material is a Nickel-based directionally solidified (DS) superalloy, where the DS, load, and crack propagation axes are set to be perpendicular to each other. The magnitude of J is estimated using 2-dimensional models simulated after an experimental result; (i) with the actual crack shape and grain arrangement, (ii) with the actual crack shape in the homogeneous body, and (iii) with the straight crack in homogeneous body (averaged deformation behavior of the material). The microscopic inclination of crack propagation direction causes the sporadic drop of J at the point where the crack direction is largely inclined from the direction normal to the load axis. The anisotropy of grain causes the stepwise change in the a (crack length) - J relationship. These directly relate to the change in the crack propagation rate in the transgranular cracking. Then, J, which takes into accounts the factors, correlates well with the crack propagation rate in the transgranular cracking. The grain-boundary cracking possesses fluctuated J and shows weaker resistance against the propagation than the transgranular one.

INTRODUCTION

On a macroscopic scale, though the fatigue crack propagation in a polycrystalline superalloy is governed by the effective stress intensity factor range, \( \Delta K_{\text{eff}} \) [1-3], it have eminent fluctuation on a microscopic scale due to the network of grain boundaries [4-8]. In other words, the grain is one of the strongest influential factors on the propagation. \( \Delta K_{\text{eff}} \) is also applicable to the crack propagation in a single-crystal superalloy [9-16]. However, little research work has been carried out on the fatigue crack growth behavior of directionally solidified (DS) superalloys from the viewpoint of fracture mechanics [17-19]. The grain size of DS superalloy is more than 100 mm on the major and about
0.2 to 5 mm on the minor axis. As these are in the same order of length as a main crack in a real component, the inhomogeneity and anisotropy due to the aligned multi-grains may give characteristic influence on the propagation in fatigue.

In this research, the effects of microstructure (the microscopic inclination of crack shape and the elastic anisotropy of each grain) on the fracture mechanics parameter are investigated by means of an elastic finite element analysis (FEA).

CRACK PROPAGATION PROPERTY EXPERIMENTALLY OBSERVED IN A HIGH-TEMPERATURE FATIGUE OF DS SUPERALLOY [20]

In a previous paper, authors reported the crack propagation property in a high temperature fatigue of a γ/γ'-precipitation-strengthened DS superalloy, whose chemical composition is C-0.10, Al-3.03, B-0.02, Co-9.56, Cr-13.93, Mo-1.56, Ta-2.77, Ti-4.90, W-3.86, Zr-0.01, Ni-Bal, in wt%. Here, a crack-centered-plate specimen (Fig. 1(a)), where the DS axis was set to be perpendicular to the flat section, was subjected to a load-controlled uni-axial cyclic loading under the temperature of 1143K. The loading waveform was triangular with the Max. / Min. stresses of 400, and -200MPa, respectively, with the frequency of 0.13 Hz. The crack propagation behavior, which had no effect of creep, was carefully observed during the test and the crack propagation rate, \( da/dN \), against the crack length was obtained as shown in Fig. 2. Here, \( a \) is the half crack length along the \( x \) axis (Fig. 1(b)). The crack propagation rate fluctuated during the crack propagation. The notable fluctuation of \( da/dN \) was observed in the intergranular cracking, while the transgranular cracking showed the averaged \( da/dN \). At the peak of fluctuation, \( da/dN \) was accelerated to \( 10^{-2} \) [mm/cycle] at \( a=1.3\text{mm} \) which was 10 times faster than the average.

Fig. 1 Geometry of center-cracked plate specimen, crack profile with grain sketch, and the boundary condition of FEA
The flat surface of the specimen was mechanically and electro-chemically polished after the crack propagation test in order to remove the oxidation. Then, the distribution of crystallographic orientation was evaluated by means of an Electron-Back-Scattering-diffraction-Pattern (EBSP). Figure 1(b) shows the grain arrangement and its crystallographic orientations on the specimen surface. The fatigue crack path was also traced out.

**ANALYTICAL PROCEDURE**

Finite element analyses (FEA) are carried out using a general-purpose FEA code, MSC/MARC 2003. Boundary conditions are shown in Fig. 1(b). The homogeneous remote tensile stress of 400MPa is applied controlling the y-displacements at the nodes of upper end. Since the tested material is in the small-scale-yielding condition during the fatigue loading, the analyses are conducted under the linear elastic condition. Here, J-integral \[ J \], is employed as a fracture mechanics parameter which represents the driving force of crack propagation.

In order to clarify the total effects of the elastic anisotropy of real grains and the microscopic inclination of crack shape on the magnitude of \( J \), 3 types of analyses listed in Table 1 are conducted;

(i) Analysis considering the grain arrangement and the microscopic inclination of crack shape  
(ii) Analysis for the microscopically inclined crack in the homogeneous body  
(iii) Analysis for the straight crack in the homogeneous body

Although there is inhomogeneity in smaller scale such as dendrite or \( \gamma / \gamma' \) structure, the effect is out of scope in this paper. The effects of smaller scale inhomogeneity are involved in the material constants; the crack propagation resistance of material.
Table 1 Definition of calculated J integral

<table>
<thead>
<tr>
<th>Model No.</th>
<th>Symbol</th>
<th>Model Crack shape</th>
<th>Material property</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>(i)</td>
<td>$J_{\text{aniso}}$</td>
<td>Actual</td>
<td>Multi-grains, anisotropic</td>
<td>Energy release rate supporting both effects of the “microscopic anisotropy” related to grain arrangement and the “microscopic inclination of crack shape”</td>
</tr>
<tr>
<td>(ii)</td>
<td>$J_{\text{iso}}$</td>
<td>Actual</td>
<td>Isotropic</td>
<td>Energy release rate supporting the effect of “microscopic inclination of crack shape”</td>
</tr>
<tr>
<td>(iii)</td>
<td>$J_{\text{straight}}$</td>
<td>Straight</td>
<td>Isotropic</td>
<td>Energy release rate of straight crack in homogeneous and isotropic material</td>
</tr>
<tr>
<td>(iv)</td>
<td>$J_{\text{grain}}$</td>
<td>Straight</td>
<td>Multi-grains, anisotropic</td>
<td>Energy release rate supporting the effect of “microscopic anisotropy” related to grain arrangement</td>
</tr>
</tbody>
</table>

Analysis (i) simulates the grain shape and its anisotropic stiffness within the area of 3 or 4 grains near the crack. Here, the elastic stiffness in each grain is given as $C_{11}=201.5$, $C_{12}=137.1$, and $C_{44}=98.5$ (unit in GPa), which are evaluated by interpolating those in the pure γ and pure γ’ [22] for the γ’-volume fraction (26%) of tested material [23]. The outer part of the model, where the grain shape is not simulated, has the averaged stiffness in the xy-plane. Finite element meshes consists of 4-nodes quadrilateral elements and few triangular elements. The size of element on a side is around 0.05mm near the grain-boundary, and around 0.01mm near the crack propagation path. The number of nodes is around 70,000. The [001] direction of each grains are set to be perpendicular to the surface in this analysis.

Analysis (iii) provides $J$ of straight crack in homogeneous material. The crack direction is perpendicular to the load axis.

Analyses are conducted for various crack lengths from 0.675mm to 4.000mm with the increment of about 0.025mm. $J$ is evaluated by the region integration method [24].

$J$-integrals obtained by analyses (i), (ii) and (iii) are denoted by $J_{\text{aniso}}$, $J_{\text{iso}}$, and $J_{\text{straight}}$, respectively.

In order to examine the effect of grain arrangement on the stress distribution of the material, an additional analysis with actual grains is conducted on the body without the crack and notch. Here, the notch is filled up by the material with the averaged stiffness.

**ANALYTICAL RESULTS**

Figure 3 shows $\sigma_y$ under the remote tension of 400MPa in the uncracked body with the actual grains. $\sigma_y$ fluctuates from 200 to 700MPa (Fig. 3(a)). Figures 3(b) and 3(c) show the magnified views near the highest stress point. The solid and dotted arrows in the figures show the crystallographic directions of $<100>$ and $<110>$, respectively. The former has the lowest young’s modulus, while the latter has the highest in the xy plane.
The maximum stress appears in a grain with the crystallographic direction of around $\langle 110 \rangle$ surrounded by the grains around $\langle 100 \rangle$. According to the constraint of deformation, the center grain shows relatively high stress and low strain.

Figure 4 shows the change in the magnitudes of $J_{\text{aniso}}$ and $J_{\text{straight}}$ against the crack length $a$. Although both show the similar trend in global, $J_{\text{aniso}}$ exhibits the sporadic decrease to $1/2$ to $1/3$ of the average. The sketch of grain arrangement near the crack is shown in Fig. 4, where the cross point of grain-boundary and crack path is indicated by vertical solid line and the grain-boundary cracking is indicated by the hatching. The stepwise fluctuation, which can be seen in Fig. 4, corresponds to the grain arrangement. It is due to the differences in the elastic modulus of the grain in the macroscopic loading axis at the crack tip.
Figure 5(a) shows the change in the magnitude of $J_{\text{iso}}$ comparing with that of $J_{\text{straight}}$ against the crack length $a$. This shows the effect of microscopic inclination of crack shape on $J$. $J_{\text{iso}}$ roughly corresponds to $J_{\text{straight}}$, while $J_{\text{iso}}$ shows the sporadic decreases. The sporadic decreases in Figs. 4 and 5(a) are caused by the crack shape. The gray-colored solid line in Fig. 5(a) shows the profile of crack path. It can be seen that $J_{\text{iso}}$ decreases when the crack path inclined largely apart from the macroscopic crack propagation direction. More precisely, this occurs when the microscopic crack direction deviates more than 40 degree from the macroscopic one. As such regions are less than 10% of total crack path, the crack shape gives limited effect on the magnitude of $J$.

The ratio, $J_{\text{iso}} / J_{\text{straight}}$, represents the effect of microscopic crack shape. Therefore, dividing $J_{\text{aniso}}$ by the ratio,

\[
\frac{J_{\text{grain}}}{J_{\text{iso}}} = \frac{J_{\text{uniso}}}{J_{\text{iso}}/J_{\text{straight}}}
\]

may give the effect of microstructural deformation on $J$. Figure 5(b) shows the relationship between $J_{\text{grain}}$ and $a$. While it is continuous in a grain, it jumps when the crack crosses a grain-boundary. $J$ eminently fluctuates at the grain-boundary cracking. It is attributed to the constraint of deformation due to neighboring grains. Since the stress fluctuates near a grain-boundary as shown in Fig. 3(b), $J$ also fluctuates in the same manner. The largest peak in $J$ indicated by solid arrow in Fig. 5(b) is observed near the grain-boundary with an acute shape, where the stress concentration is relatively high.

![Fig. 5 Effect of microscopic inclined crack shape](image)

**COMPARISON OF RESULTS WITH EXPERIMENTS**

Figure 6 shows the relationship between the crack propagation rate $da/dN$ (obtained by the fatigue crack propagation test) and $J_{\text{grain}}$ (obtained by the analyses). The transgranular cracks fall in a single $da/dN$-$J_{\text{grain}}$ relationship. The plots of intergranular cracks are categorized into 2 groups. One is on the same $da/dN$-$J_{\text{grain}}$ relationship on that
in the transgranular cracks, and the other shows far higher \( da/dN \) than those in the transgranular cracks. The crack propagation rate of the latter group is around 3 to 5 times faster than that in the transgranular one. This group corresponds to the peak \( da/dN \) in Fig. 2 \((a=1.3\text{mm})\). Since the crack propagation rate is governed by the relative magnitude of crack driving force against the crack propagation resistance of the material, it is suggested that the increase of crack propagation rate here is caused by decrease of crack propagation resistance at the grain-boundary.

![Fig. 6 Comparison of crack propagation rates in various microscopic crack paths](image)

### CONCLUSIONS

The effects of microscopic inhomogeneities on the crack driving force (J-integral) are investigated in fatigue of a directionally solidified (DS) superalloy using finite-element-analyses (FEA). The actual grain arrangement (grain shape and its anisotropic elastic stiffness) and the microscopic inclination of crack shape are modeled in the FE-models. Three types of \( J \), such as \( J_{\text{aniso}} \), \( J_{\text{iso}} \), and \( J_{\text{grain}} \) are calculated, where \( J_{\text{aniso}} \) takes into account the both effects, \( J_{\text{iso}} \) does only the effect of latter, and \( J_{\text{grain}} \) does only the effect of former. The followings are summary of the analytical results.

1. The stress in the actual grain arrangement is fluctuated due to the difference of elastic modulus in the stress-applied-direction. The highest stress appears at the grain with high elastic modulus surrounded by the ones with the low elastic modulus.
2. \( J_{\text{iso}} \) shows the sporadic decrease when the microscopic crack inclines largely (> 40 degree) from the macroscopic propagation direction.
3. The elastic modulus of each grain brings about the stepwise change in \( J_{\text{grain}} \).
4. The fluctuation of \( J_{\text{grain}} \) at intergranular crack indicates that the crack driving force depends on the relative stress / strain constraint near the grain boundaries. The highest peak of \( J_{\text{grain}} \) is at the point where the grain has acuminate shape.
5. \( da/dN-J_{\text{grain}} \) relationship of transgranular crack falls into a single line. This suggests that the fluctuation of crack propagation rate in the transgranular cracking is caused by the difference in the driving force. On the other hand, \( da/dN \) in the intergranular crack
shows the eminent acceleration. It suggests the lower crack propagation resistibility at the grain-boundary than that inside of the grain.

REFERENCES

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